



Updated Application Data Sheet

Application Information

Application number: 10/574,800
Filing Date: April 6, 2006
Application Type: Regular
Title: PRESSURE-SENSITIVE ADHESIVE SHEET
AND METHOD OF MANUFACTURING THE
SAME
Attorney Docket Number: 24-033-TN

Applicant Information

Applicant No. 1

Applicant Authority Type: Inventor
Primary Citizenship Country: Japan
Status: Full Capacity
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Applicant No. 2

Applicant Authority Type: Inventor
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Applicant No. 3

Applicant Authority Type: Inventor
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Assignee Information

Name of Assignee: LINTEC Corporation
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Correspondence Information

Correspondence Customer Number: 23400

Representative Information

Representative Customer Number: 23400

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP2004/013122 filed on September 9, 2004.

Foreign Priority Information

Country:	Application Number:	Filing Date:	Priority Claimed:
JAPAN	2003-352297	October 10, 2003	YES